



PTO/SB/08A (10-01)
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Substitute for form 1449A/PTO		Complete if Known	
INFORMATION DISCLOSURE STATEMENT BY APPLICANT (use as many sheets as necessary)		Application Number	10/065,209
		Filing Date	9/25/2002
		First Named Inventor	Longden et al.
		Art Unit	TBA
		Examiner Name	TBA
Sheet	1	of	2
		Attorney Docket Number	73591

FOREIGN PATENT DOCUMENTS							
Examiner Initials*	Cite No. ¹	Foreign Patent Document		Publication Date MM-DD-YYYY	Name of Patentee or Applicant of Cited Document	Pages, Columns, Lines, Where Relevant Passages or Relevant Figures Appear	T ⁶
		Country Code ³ - Number ⁴ - Kind Code ⁵ (if known)					
DL		FR 2584 863		01-16-1987			
		EP 0160 327		11-06-1985			
		JP 56 103452		08-18-1981			
		JP 60 180150		09-13-1985			
		JP 61 004249		01-10-1986			
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		JP 2 278740		11-15-1990			

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Substitute for form 1449B/PTO				Complete if Known	
				Application Number	10/065,209
INFORMATION DISCLOSURE STATEMENT BY APPLICANT (use as many sheets as necessary)				Filing Date	9/25/2002
				First Named Inventor	Longden et al.
				Group Art Unit	TBA
				Examiner Name	TBA
Sheet	2	of	2	Attorney Docket Number	73591

OTHER PRIOR ART – NON PATENT LITERATURE DOCUMENTS			
Examiner Initials*	Cite, No.	Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc.), date, page(s), volume-issue number(s), publisher, city and/or country where published.	T ²
		"Electronics Packaging and Production", p 26-27	
		Electronic Materials and Processes, Consulting and Short Courses:, p 1-3	
		"Electronic Materials Handbook", p 470-483	
/J.L.W./		C. Harper, "Electronic Packaging and Interconnection Handbook", McGraw Hill p 6.41-6.49 1997	
		M. P. Baze et al., "Latch-up Paths in Bipolar Integrated Circuits", IEEE Transactions on Nuclear Science, December 1986, Vol. NS-33 No. 6	
		A. H. Johnston et al., "The Effect of Temperature on Single-Particle Latch-Up", IEEE Transactions on Nuclear Science, December 1991, Vol. 38 No. 6	
		Song et al., "Parametric Investigation of Latch-Up Sensitivity in 1.25 CMOS Technology", IEEE Transactions on Nuclear Science, December 1987, Vol. NS-34 No. 6	
		D. G. Millward et al., "The Effectiveness of RAD-PAK ICs for Space Radiation Hardening, 1990 Proceedings 40 th Electronic Components and Technology Conference IEEE, Vol. 2 pp 913-916, 1990.	
		C. Harper, "Electronic Packaging and Interconnection Handbook", McGraw Hill 1997, p 6.34	

Examiner Signature	/Jenny L. Wagner/	Date Considered	01/03/2008
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